

650V N-Channel MOSFET

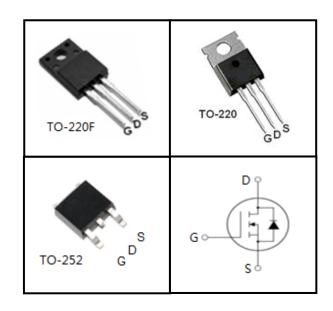
FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

Device Marking and Package Information				
Device	Package	Marking		
CS8N65F	TO-220F	CS8N65F		
CS8N65P	TO-220	CS8N65P		
CS8N65D	TO-252	CS8N65D		
CS8N65F-B	TO-220F-B	CS8N65F-B		



Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted						
Parameter	Symbol		l lmit			
Parameter		TO-220F	TO-220	TO-252	Unit	
Drain-Source Voltage (V _{GS} = 0V)	V _{DSS}	650			V	
Continuous Drain Current	I _D		8		Α	
Pulsed Drain Current (note1)	I _{DM}	32			А	
Gate-Source Voltage	V_{GSS}		± 30		V	
Single Pulse Avalanche Energy (note2)	E _{AS}	245			mJ	
Avalanche Current (note1)	I _{AS}	7		А		
Repetitive Avalanche Energy (note1)	E _{AR}	147		mJ		
Power Dissipation (T _C = 25°C)	P_{D}	64	10	07	W	
Operating Junction and Storage Temperature Range	T_J,T_stg	-55~+150			∘C	

Thermal Resistance					
Parameter	Symbol	Value			11
		TO-220F	TO-220	TO-252	Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	1.95	1.17		°C/W
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	60		°C/VV

Specifications $T_J = 25^{\circ}C$, unless otherwise noted							
Parameter	Symbol	To at Oom distance	Value			l la it	
		Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	650			V	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 650V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μΑ	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		4.0	V	
Drain-Source On-Resistance (Note3)	R _{DS(on)}	V _{GS} = 10V, I _D = 4A		0.95	1.15	Ω	
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0V,$ $V_{DS} = 25V,$ f = 1.0MHz		1110		pF	
Output Capacitance	C _{oss}			106			
Reverse Transfer Capacitance	C _{rss}			13			
Total Gate Charge	Q_g	$V_{DD} = 520V, I_D = 8A,$ $V_{GS} = 10V$		37		nC	
Gate-Source Charge	Q_{gs}			5			
Gate-Drain Charge	Q_{gd}	93		24			
Turn-on Delay Time	t _{d(on)}			39			
Turn-on Rise Time	t _r	$V_{DD} = 325V, I_{D} = 8A,$		10		ns	
Turn-off Delay Time	t _{d(off)}	$R_G = 25 \Omega$		152			
Turn-off Fall Time	t _f			42			
Drain-Source Body Diode Character	istics						
Continuous Body Diode Current	I _S	T			8	^	
Pulsed Diode Forward Current	I _{SM}	T _C = 25 °C			32	A	
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}\text{C}, I_{SD} = 4\text{A}, V_{GS} = 0\text{V}$			1.4	V	
Reverse Recovery Time	t _{rr}	$V_{GS} = 0V, I_{S} = 8A,$		601		ns	
Reverse Recovery Charge	Q _{rr}	di _F /dt =100A /µs		2.3		μC	

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 10mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}C$
- 3. Pulse Test: Pulse width ≤ 325µs, Duty Cycle ≤ 1%



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^{\circ}C$)

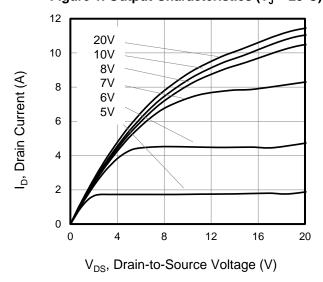


Figure 3. Drain Current vs. Temperature

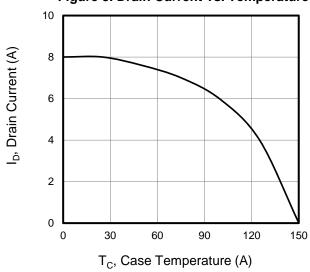


Figure 5. Transfer Characteristics

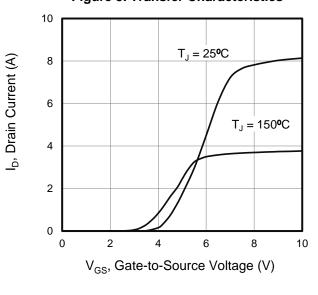
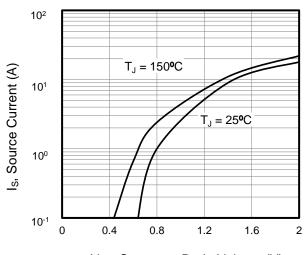
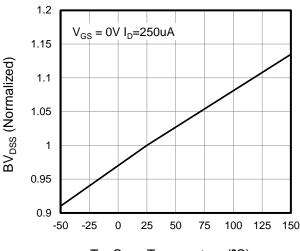


Figure 2. Body Diode Forward Voltage



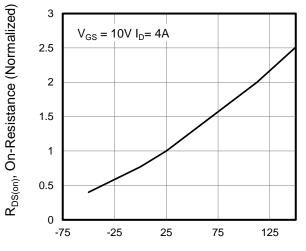
V_{SD}, Source-to-Drain Voltage (V)

Figure 4. BV_{DSS} Variation vs. Temperature



T_C, Case Temperature (°C)

Figure 6. On-Resistance vs. Temperature



 T_J , Junction Temperature (${}^{\rm o}{\rm C}$)



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

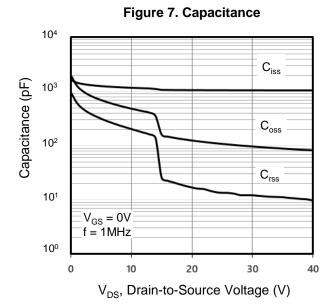


Figure 9. Transient Thermal Impedance

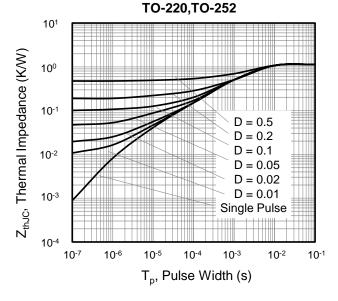


Figure 8. Gate Charge

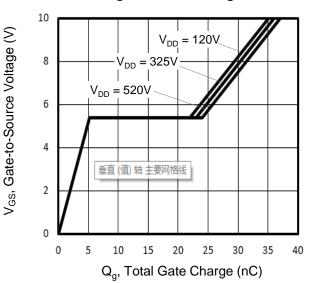


Figure 10. Transient Thermal Impedance

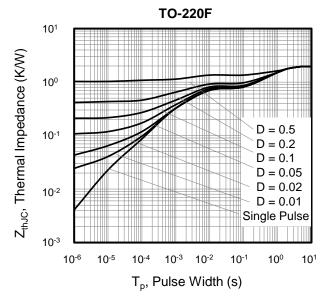




Figure A: Gate Charge Test Circuit and Waveform

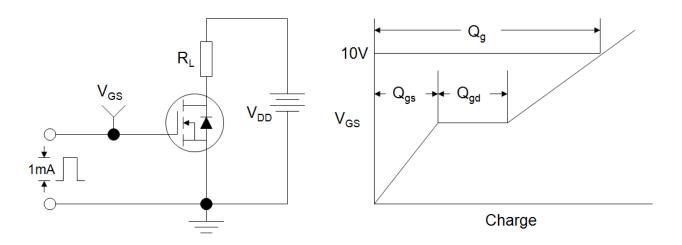


Figure B: Resistive Switching Test Circuit and Waveform

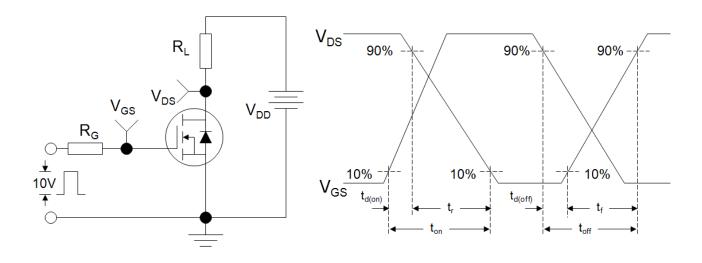
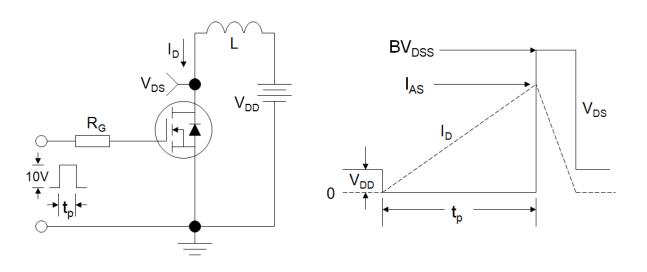
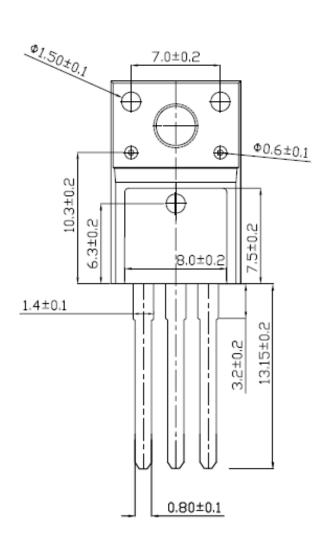


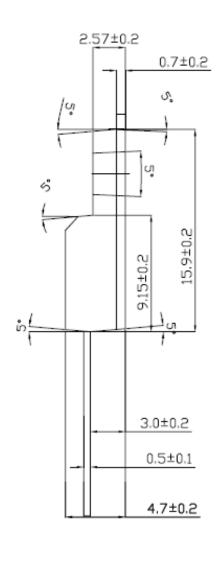
Figure C: Unclamped Inductive Switching Test Circuit and Waveform





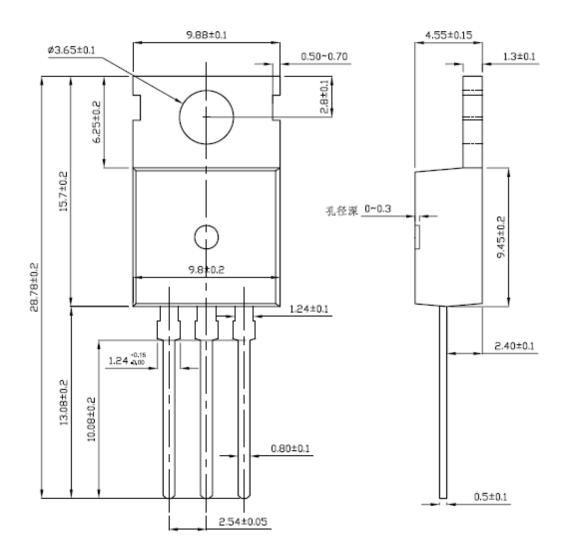
TO-220F





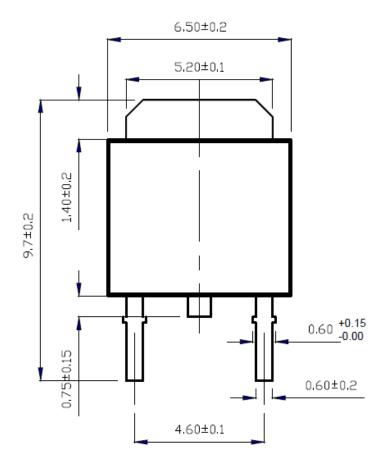


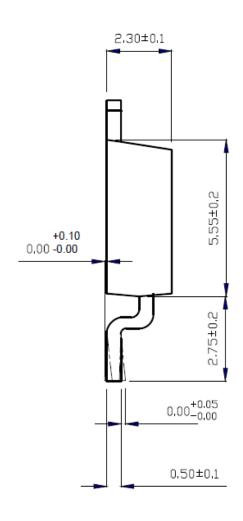
TO-220





TO-252







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